



## SSCV10N65GT4

### N-Channel Enhancement Mode Power MOSFET

#### ➤ Features

| $V_{DS}$ | $V_{GS}$  | $R_{DS(ON)}$ Typ. | $I_D$ |
|----------|-----------|-------------------|-------|
| 650V     | $\pm 30V$ | $0.84\Omega@10V$  | 5A    |

#### ➤ Description

- This device is N-Channel enhancement MOSFET.
- Fast Switching.
- Improved dv/dt Capability.

**100% UIS +  $\Delta V_{DS}$  +  $R_g$  Tested!**

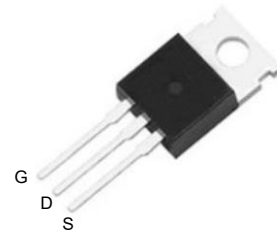
#### ➤ Applications

- Load Switch
- PWM Application
- Power Management

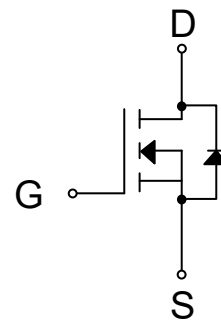
#### ➤ Ordering Information

| Device       | Package  | Shipping |
|--------------|----------|----------|
| SSCV10N65GT4 | TO220-3L | 50/Tube  |

#### ➤ Pin Configuration



**TO220-3L (Top View)**



**Pin Configuration**



**Marking**

(XXYY: Internal Traceability Code)



➤ **Absolute Maximum Ratings ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

| Symbol          | Parameter                                   | Ratings                   | Unit               |
|-----------------|---|---------------------------|--------------------|
| $V_{DS}$        | Drain-to-Source Voltage                     | 650                       | V                  |
| $V_{GS}$        | Gate-to-Source Voltage                      | $\pm 30$                  | V                  |
| $I_D$           | Continuous Drain Current                    | $T_J=25^{\circ}\text{C}$  | A                  |
|                 |   | $T_J=100^{\circ}\text{C}$ |                    |
| $I_{DM}$        | Pulsed Drain Current <sup>a</sup>           | 40                        | A                  |
| $E_{AS}$        | Single Pulsed Avalanche Energy              | 405                       | mJ                 |
| $P_D$           | Power Dissipation, $T_J=25^{\circ}\text{C}$ | 125                       | W                  |
| $T_{STG} / T_J$ | Junction & Storage Temperature Range        | -55 to 150                | $^{\circ}\text{C}$ |

➤ **Thermal Resistance Ratings ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

| Symbol          | Parameter  | Ratings | Unit                        |
|-----------------|--|---------|-----------------------------|
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient <sup>b</sup> | 62      | $^{\circ}\text{C}/\text{W}$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case                 | 1       |                             |

Note:

a. Repetitive Rating: Pulsed width limited by maximum junction temperature.

b.  $R_{\theta JA}$  is measured with the device mounted on a minimum recommended pad of 2oz copper FR4 PCB.

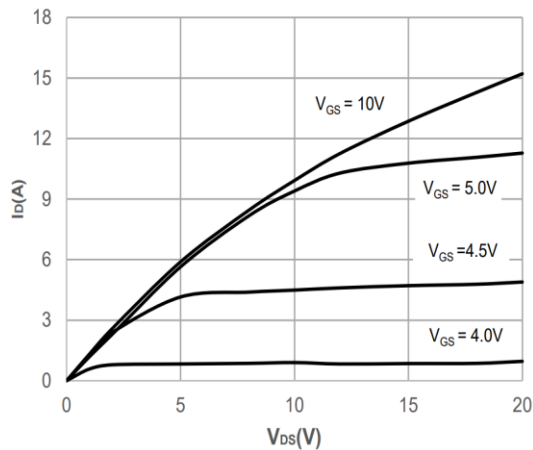


➤ **Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

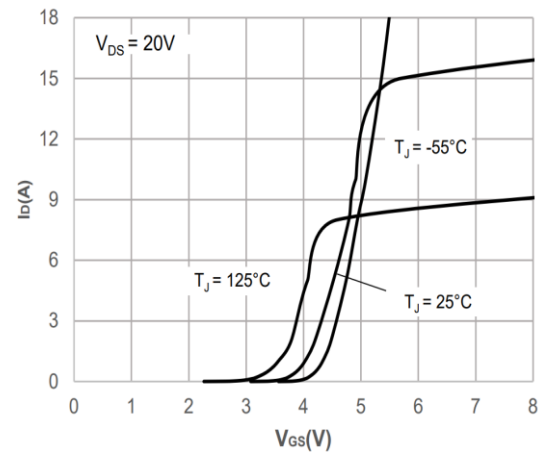
| Parameter  | Symbol               | Test Conditions  | Min. | Typ. | Max. | Unit |
|--|----------------------|--|------|------|------|------|
| Drain-Source Breakdown Voltage                           | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA   | 650  |      |      | V    |
| Zero Gate Voltage Drain Current                          | I <sub>DSS</sub>     | V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V   |      |      | 1.0  | μA   |
| Gate-Source Leak Current                                 | I <sub>GSS</sub>     | V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V   |      |      | ±100 | nA   |
| Gate Threshold Voltage                                   | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                                   | 2    | 3    | 4    | V    |
| Drain-Source On-Resistance                               | R <sub>DS(on)</sub>  | V <sub>GS</sub> = 10V, I <sub>D</sub> = 5A   |      | 0.84 | 1.09 | Ω    |
| Input Capacitance  | C <sub>ISS</sub>     | V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V,<br>f = 1MHz                                     |      | 1560 |      | pF   |
| Output Capacitance                                       | C <sub>OSS</sub>     |  |      | 136  |      |      |
| Reverse Transfer Capacitance                             | C <sub>RSS</sub>     |  |      | 19   |      |      |
| Total Gate Charge  | Q <sub>G</sub>       | V <sub>GS</sub> = 0 to 10V, V <sub>DS</sub> = 520V,<br>I <sub>D</sub> = 10A                  |      | 37   |      | nC   |
| Gate to Source Charge                                    | Q <sub>GS</sub>      |  |      | 8    |      |      |
| Gate to Drain Charge                                     | Q <sub>GD</sub>      |  |      | 15   |      |      |
| Turn-on Delay Time                                       | T <sub>D(ON)</sub>   | V <sub>GS</sub> = 10V, V <sub>DS</sub> = 310V,<br>I <sub>D</sub> = 10A, R <sub>G</sub> = 24Ω |      | 23   |      | ns   |
| Rise Time  | T <sub>r</sub>       |  |      | 37   |      |      |
| Turn-off Delay Time                                      | T <sub>D(OFF)</sub>  |  |      | 104  |      |      |
| Fall Time  | T <sub>f</sub>       |  |      | 45   |      |      |
| Maximum Continuous Drain to Source Diode Forward Current | I <sub>S</sub>       |  |      |      | 10   | A    |
| Maximum Pulsed Drain to Source Diode Forward Current     | I <sub>SM</sub>      |  |      |      | 40   | A    |
| Drain to Source Diode Forward Voltage                    | V <sub>SD</sub>      | V <sub>GS</sub> = 0V, I <sub>S</sub> = 10A   |      |      | 1.2  | V    |
| Body Diode Reverse Recovery Time                         | T <sub>rr</sub>      | I <sub>F</sub> = 10A, di/dt = 100A/μs  |      | 423  |      | ns   |
| Body Diode Reverse Recovery Charge                       | Q <sub>rr</sub>      |  |      | 4.4  |      | μC   |



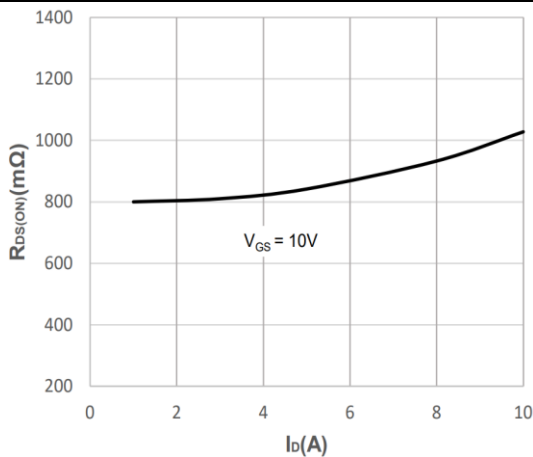
## ➤ Typical Performance Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise noted)



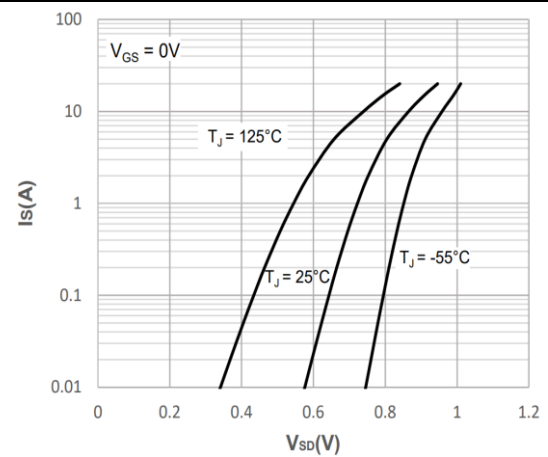
**Figure 1: Output Characteristics**



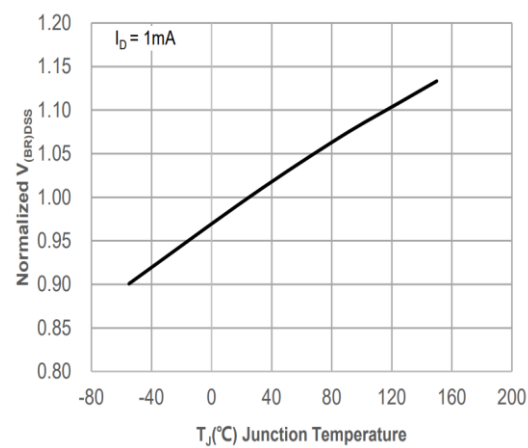
**Figure 2: Typical Transfer Characteristics**



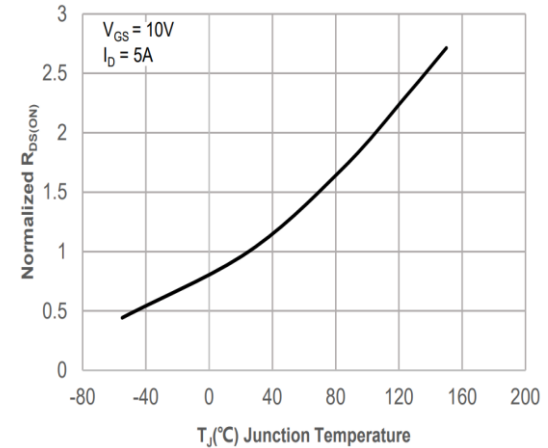
**Figure 3: On-resistance vs. Drain Current**



**Figure 4: Body Diode Characteristics**



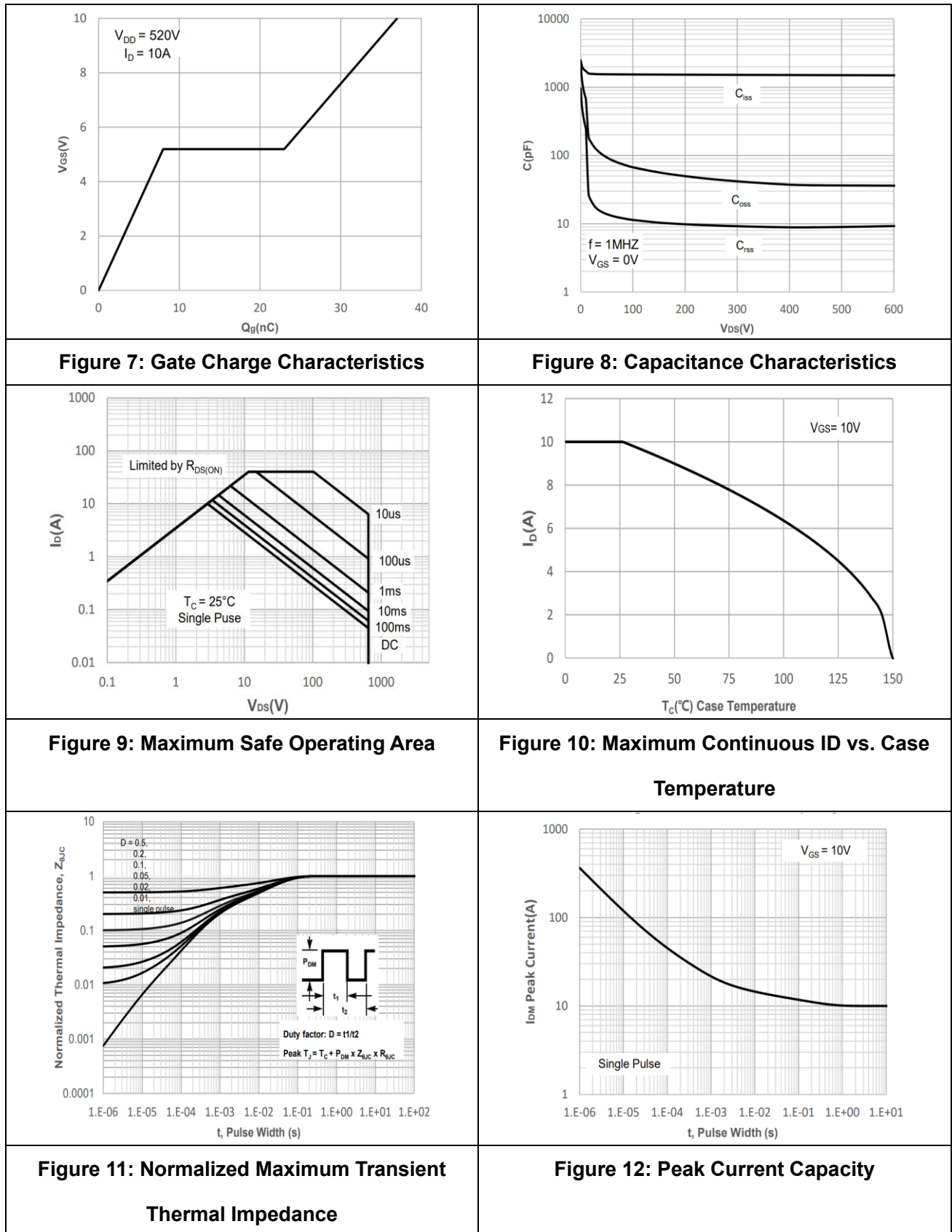
**Figure 5: Normalized Breakdown voltage vs. Junction Temperature**



**Figure 6: Normalized on Resistance vs. Junction Temperature**



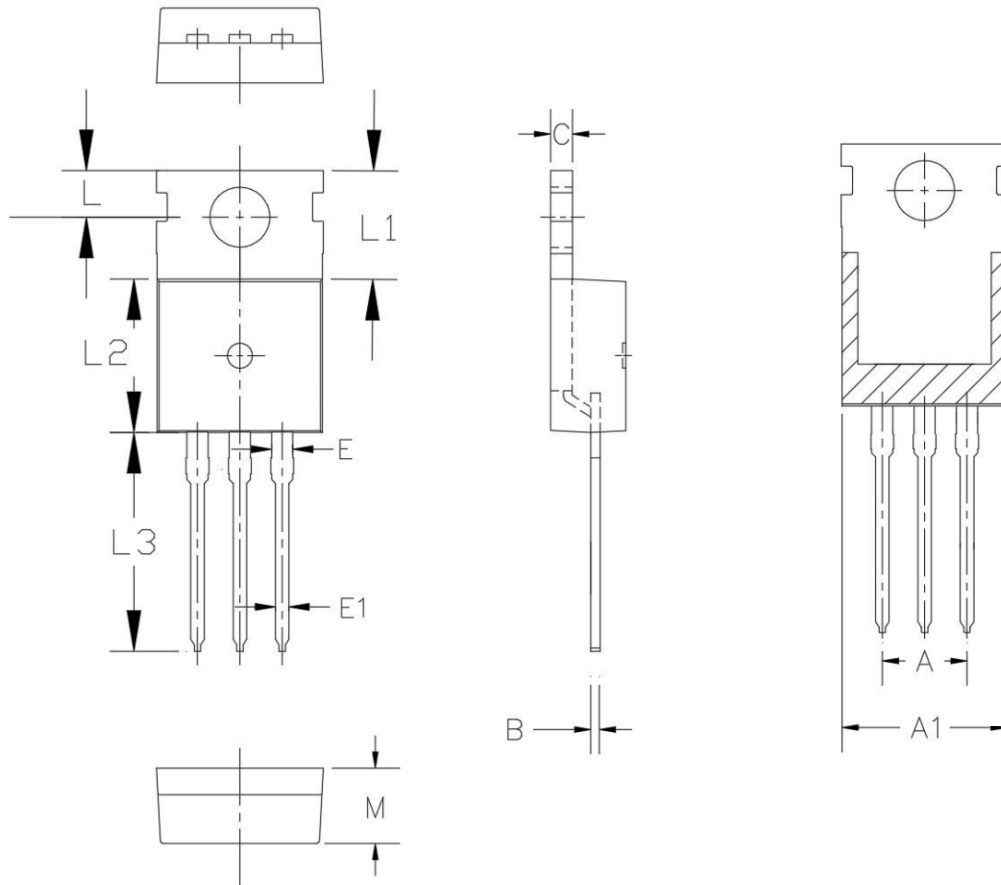
## ➤ Typical Performance Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise noted)





## ➤ Package Information

TO220-3L



| Symbol | MILL IMETER |       |       |
|--------|-------------|-------|-------|
|        | Min         | Nom   | Max   |
| A      | 5.08 BSC    |       |       |
| A1     | 9.00        | 10.00 | 11.00 |
| B      | 0.33        | --    | 0.65  |
| C      | 1.20        | --    | 1.40  |
| E      | 1.17        | --    | 1.37  |
| E1     | 0.60        | --    | 1.10  |
| L      | 2.50        | --    | 3.00  |
| L1     | 6.3         | 6.5   | 6.7   |
| L2     | 8.95        | --    | 9.75  |
| L3     | 12.88       | --    | 13.40 |
| M      | 4.30        | --    | 4.70  |



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